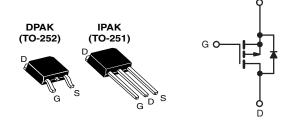


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY							
V _{DS} (V)	- 60						
R _{DS(on)} (Ω)	V _{GS} = - 10 V	0.28					
Q _g (Max.) (nC)	19						
Q _{gs} (nC)	5.4						
Q _{gd} (nC)	11						
Configuration	Single						



P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR9024, SiHFR9024)
- Straight Lead (IRFU9024, SiHFU9024)
- Available in Tape and Reel
- P-Channel
- Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effictiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFO	ORMATION				
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)
Lead (Pb)-free and Halogen-free	SiHFR9024-GE3	SiHFR9024TR-GE3ª	SiHFR9024TRL-GE3 ^a	SiHFR9024TRR-GE3ª	SiHFU9024-GE3
Lead (Pb)-free	IRFR9024PbF	IRFR9024TRPbF ^a	IRFR9024TRLPbFa	IRFR9024TRRPbF ^a	IRFU9024PbF
	SiHFR9024-E3	SiHFR9024T-E3 ^a	SiHFR9024TL-E3 ^a	SiHFR9024TR-E3 ^a	SiHFU9024-E3

Note

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	- 60	v
Gate-Source Voltage			V _{GS}	± 20	v
Continuous Drain Current	T _C = 25 °C T _C = 100 °C	L_	- 8.8		
Continuous Drain Gurrent	I _D	- 5.6	А		
Pulsed Drain Current ^a			I _{DM}	- 35	
Linear Derating Factor			0.33	W/°C	
Linear Derating Factor (PCB Mount) ^e			0.020	W/ C	
Single Pulse Avalanche Energy ^b		E _{AS}	300	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 8.8	Α
Repetitive Avalanche Energy ^a		E _{AR}	5.0	mJ	
Maximum Power Dissipation	25 °C	D	42	w	
Maximum Power Dissipation (PCB Mount) ^e	P _D	2.5	vv		
Peak Diode Recovery dV/dt ^c	dV/dt	- 4.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature) ^d	Soldering Recommendations (Peak Temperature) ^d for 10 s				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = -25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 4.5 mH, $R_g = 25 \Omega$, $I_{AS} = -8.8 \text{ A}$ (see fig. 12). c. $I_{SD} \leq -11 \text{ A}$, dl/dt $\leq 140 \text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DS}$, $T_J \leq 150 \text{ °C}$.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

S13-0168-Rev. D, 04-Feb-13

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HALOGEN

FREE Available



Vishay Siliconix

THERMAL RESISTANCE RAT	THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT				
Maximum Junction-to-Ambient	R _{thJA}	-	-	110					
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W				
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0					

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		<u>.</u>					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	- 0.063	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
		V _{DS} =	- 60 V, V _{GS} = 0 V	-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 48 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 5.3 A ^b	-	-	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	- 25 V, I _D = - 5.3 A	2.9	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	570	-	
Output Capacitance	C _{oss}		$V_{DS} = -25 V,$	-	360	-	pF
Reverse Transfer Capacitance	C _{rss}		f = 1.0 MHz	-	65	-	
Total Gate Charge	Qg			-	-	19	
Gate-Source Charge	Q_gs	V _{GS} = - 10 V	$I_D = -11 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13^{b}	-	-	5.4	nC
Gate-Drain Charge	Q _{gd}			-	-	11	
Turn-On Delay Time	t _{d(on)}			-	13	-	
Rise Time	t _r	V _{DD} =	- 30 V, I _D = - 11 A,	-	68	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 18 \Omega$,	$R_D = 2.5 \Omega$, see fig. 10^{b}	-	15	-	ns
Fall Time	t _f			-	29	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")	from	-	4.5	-	
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	nH
Drain-Source Body Diode Characteristic	s	-					
Continuous Source-Drain Diode Current	I _S	showing	MOSFET symbol showing the		-	- 8.8	A
Pulsed Diode Forward Current ^a	I _{SM}	integral re p - n junctio		-	-	- 35	~
Body Diode Voltage	V_{SD}	T _J = 25 °C,	$I_{\rm S}$ = - 8.8 A, $V_{\rm GS}$ = 0 V ^b	-	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C I	= - 11 A, dl/dt = 100 A/µs ^b	-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25$ C, I _F	$=$ - 11 A, u/ul = 100 A/ μ S ^o	-	0.32	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	$v L_s$ and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

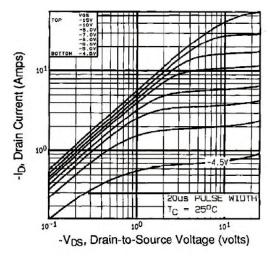


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

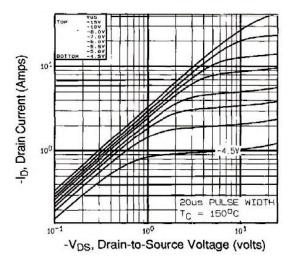


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

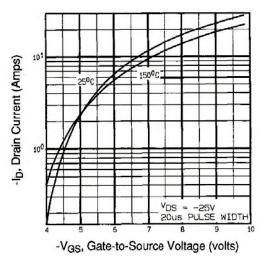


Fig. 3 - Typical Transfer Characteristics

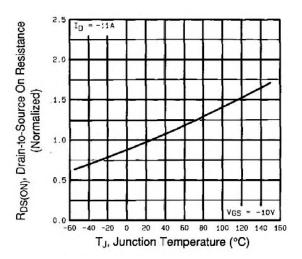


Fig. 4 - Normalized On-Resistance vs. Temperature



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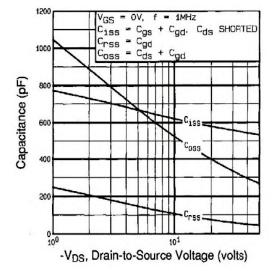


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

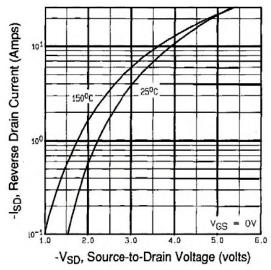


Fig. 7 - Typical Source-Drain Diode Forward Voltage

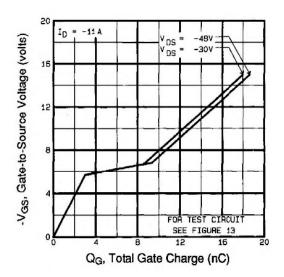


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

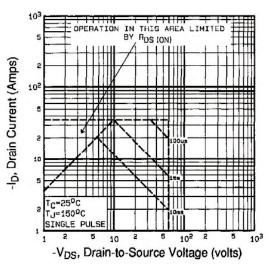


Fig. 8 - Maximum Safe Operating Area



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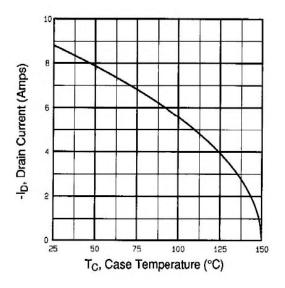


Fig. 9 - Maximum Drain Current vs. Case Temperature

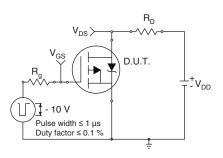


Fig. 10a - Switching Time Test Circuit

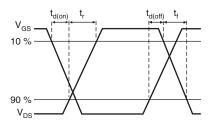


Fig. 10b - Switching Time Waveforms

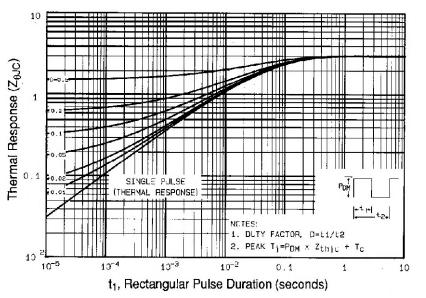


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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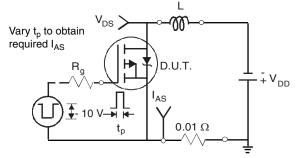


Fig. 12a - Unclamped Inductive Test Circuit

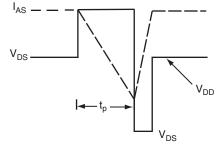


Fig. 12b - Unclamped Inductive Waveforms

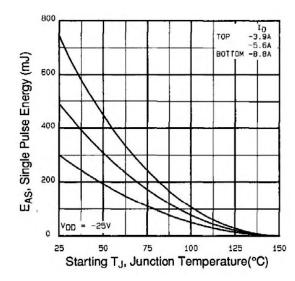


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

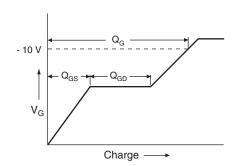


Fig. 13a - Basic Gate Charge Waveform

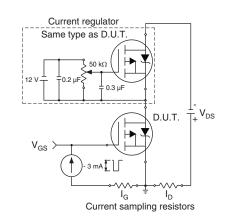


Fig. 13b - Gate Charge Test Circuit

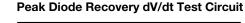
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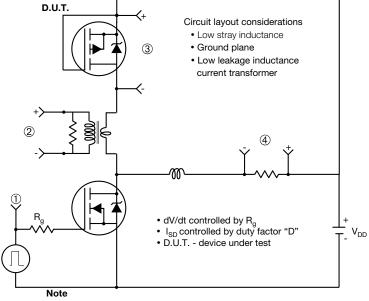
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• Compliment N-Channel of D.U.T. for driver

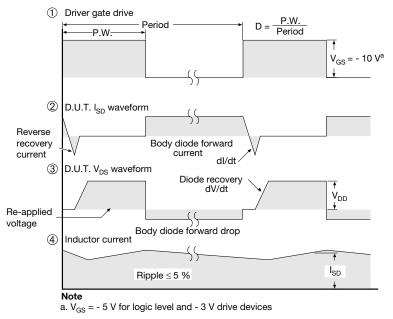


Fig. 14 - For P-Channel

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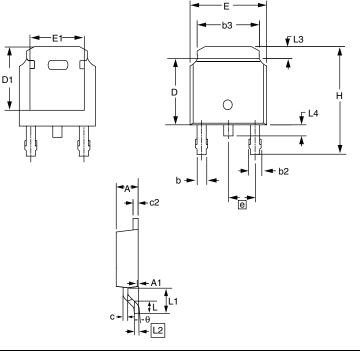
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Package Information

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TO-252AA (HIGH VOLTAGE)



	MILLI	METERS	INC	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.		
E	6.40	6.73	0.252	0.265		
L	1.40	1.77	0.055	0.070		
L1	2.74	3 REF	0.108	B REF		
L2	0.508	3 BSC	0.020 BSC			
L3	0.89	1.27	0.035	0.050		
L4	0.64	1.01	0.025	0.040		
D	6.00	6.22	0.236	0.245		
Н	9.40	10.40	0.370	0.409		
b	0.64	0.88	0.025	0.035		
b2	0.77	1.14	0.030	0.045		
b3	5.21	5.46	0.205	0.215		
е	2.280	BSC	0.090	BSC		
А	2.20	2.38	0.087	0.094		
A1	0.00	0.13	0.000	0.005		
С	0.45	0.60	0.018	0.024		
c2	0.45	0.58	0.018	0.023		
D1	5.30	-	0.209	-		
E1	4.40	-	0.173	-		
θ	0'	10'	0'	10'		

Notes

1. Package body sizes exclude mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.10 mm per side.

2. Package body sizes determined at the outermost extremes of the plastic body exclusive of mold flash, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

3. The package top may be smaller than the package bottom.

4. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.10 mm total in excess of "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.



Vishay Siliconix

TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLI	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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Vishay

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